SN54180, SN74180 9-BIT ODD/EVEN PARITY GENERATORS/CHECKERS

DECEMBER 1972-REVISED MARCH 1988

EU	NCTIO				SN54180 J OR W PACKAGE SN74180 N PACKAGE (TOP VIEW)
FUNCTION TABLE				UTS	
Σ OF H's AT A THRU H	EVEN	ODD	Σ EVEN	Σ ODD	$\begin{array}{ccc} G & \Box^{1} & \bigcirc 14 \Box & V_{CC} \\ H & \Box^{2} & 13 \Box & F \\ \end{array}$
EVEN	н	L	н	L	EVEN $\begin{bmatrix} 3 \\ 2 \end{bmatrix}$ E
ODD	н	L	L	н	
EVEN	L	н	L	н	
ODD	Ł	н	н	L	ΣΟΟΟ 🛛 6 🤤 Β
x	н	н	L	L	
х	L	L	н	н	

description

These universal, monolithic, 9-bit (8 data bits plus 1 parity bit) parity generators/checkers, utilize familiar Series 54/74 TTL circuitry and feature odd/even outputs and control inputs to facilitate operation in either odd or even-parity applications. Depending on whether even or odd parity is being generated or checked, the even or odd inputs can be utilized as the parity or 9th-bit input. The word-length capability is easily expanded by cascading.

The SN54180/SN74180 are fully compatible with other TTL or DTL circuits. Input buffers are provided so that each data input represents only one normalized series 54/74 load. A full fan-out to 10 normalized series 54/74 loads is available from each of the outputs at a low logic level. A fan-out to 20 normalized loads is provided at a high logic level to facilitate the connection of unused inputs to used inputs. Typical power dissipation is 170 mW.

The SN54180 is characterized for operation over the full military temperature range of -55° C to 125° C; and the SN74180 is characterized for operation from 0°C to 70°C.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

	Supply voltage, V _{CC} (see Note 1)																	7	v
	Input voltage																	5.5	V
	Operating free-air temperature range: SN54180 Circuits												•		-	-55°	'C to	o 125°	C
	SN74180 Circuits																		
	Storage temperature range		•	•		•	•	•	•	•	•	•	•	•	-	-65	'C to	o 150°	C
NOT	E 1: Voltage values are with respect to network ground terminal.																		

recommended operating conditions

		SN54180			SN74180			
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V	
High-level output current, IOH			-800			-800	μA	
Low-level output current, IOL	· · · · · ·		16			16	mA	
Operating free-air temperature, TA	-55		125	0		70	°C	



SN54180, SN74180 **9-BIT ODD/EVEN PARITY GENERATORS/CHECKERS**

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS [†]	L	SN5418	0		1		
			TEST CONDITIONS:	MIN	түр‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage			2			2			V
VIL	Low-level input voltage					0.8		•	0.8	V
VIK	Input clamp voltage		$V_{CC} = MIN$, $I_I = -12 \text{ mA}$			-1.5	-		-1.5	v
VOH	High-level output voltage	3	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = -800 μA	2.4	3.3		2.4	3.3		v
V _{OL}	Low-level output voltage	•	$V_{CC} = MIN, V_{IH} = 2V,$ $V_{IL} = 0.8V, I_{OL} = 16 mA$		0.2	0.4		0.2	0.4	v
lj –	Input current at maximu	im input voltage	V _{CC} = MAX, V _I = 5.5 V			1		_	1	mA
ηн	High-level input current	Any data input	Vee - MAX W = 24 V			40			40	
н	ragin-level input current	Even or odd input	V _{CC} = MAX, VI = 2.4 V			80			80	μA
կլ ե	Low-level input current	Any data input				-1.6			-1.6	
		Even or odd input	$V_{CC} = MAX, V_{I} = 0.4 V$			-3.2			-3.2	mA
los	Short-circuit output curr	ent §	V _{CC} = MAX	-20		-55	-18		-55	mA
lcc	Supply current		V _{CC} = MAX, See Note 2		34	49		34	56	mA

TTL Devices

NOTE 2: I_{CC} is measured with even and odd inputs at 4.5 V, all other inputs and outputs open.

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type. [‡]All typical values are at V_{CC} = 5 V, T_A = 25°C. § Not more than one output should be shorted at a time.

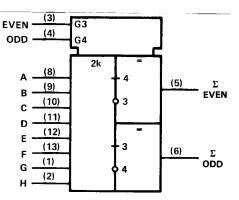
switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	ТҮР	МАХ	UNIT
^t PLH	Data	Σ Even			40	60	
^t PHL	Data	2 LVen	C _L = 15 pF, R _L = 400 s	s, 🔽	45	68	ns
^t PLH	Data	Σ Odd	Odd input grounded, See Note 3		32	48	
^t PHL	Data	2 000			25	38	ns
^t PLH	Data	ΣEven			32	48	
tPHL	Data	2 LVen	C _L = 15 pF, R _L = 400 s	s,	25	38	ns
^t PLH	Data	Σ Odd	Even input grounded, See Note 3		40	60	
^t PHL	Bata	2 000			45	68	- ns
^t PLH	Even or Odd	Σ Even or Σ Odd	$C_{L} = 15 \text{pF}, \qquad R_{L} = 400 \text{s}$	s,	13	20	
^t PHL			See Note 3		7	10	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

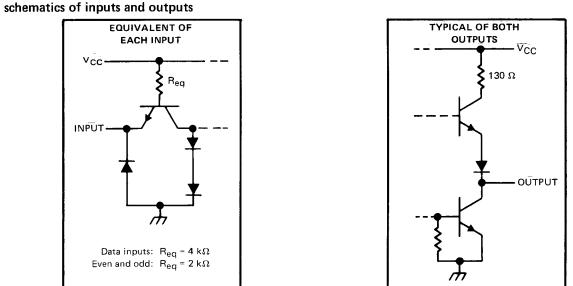
logic symbol[†]

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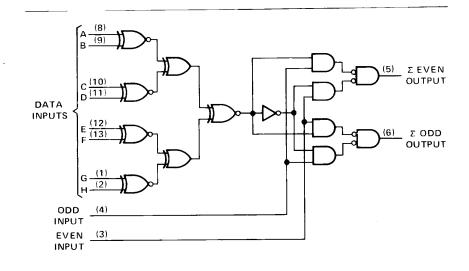
[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



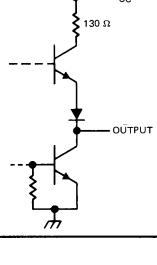


logic diagram (positive logic)

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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN54180J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SN74180N	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SN74180N	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SNJ54180J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SNJ54180J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type
SNJ54180W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SNJ54180W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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